



Material Content Data Sheet



Sales Product Name		IPS65R600E6		Issued		27. September 2017		
MA#		MA001307194						
Package		PG-TO251-3-342		Weight*		318.88 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.294	1.03	1.03	10330	10330
leadframe	non noble metal	iron	7439-89-6	0.147	0.05		462	
	inorganic material	phosphorus	7723-14-0	0.044	0.01		139	
	non noble metal	copper	7440-50-8	147.096	46.13	46.19	461296	461897
wire	non noble metal	aluminium	7429-90-5	0.502	0.16	0.16	1576	1576
encapsulation	organic material	carbon black	1333-86-4	1.405	0.44		4405	
	plastics	epoxy resin	-	24.580	7.71		77083	
	inorganic material	silicondioxide	60676-86-0	114.471	35.90	44.05	358985	440473
leadfinish	non noble metal	tin	7440-31-5	3.740	1.17	1.17	11729	11729
plating	inorganic material	phosphorus	7723-14-0	0.003	0.00		11	
	non noble metal	nickel	7440-02-0	1.421	0.45	0.45	4455	4466
solder	noble metal	silver	7440-22-4	0.074	0.02		233	
	non noble metal	tin	7440-31-5	0.059	0.02		186	
	non noble metal	lead	7439-92-1	2.835	0.89	0.93	8891	9310
heatspreader	non noble metal	iron	7439-89-6	0.019	0.01		60	
	inorganic material	phosphorus	7723-14-0	0.006	0.00		18	
	non noble metal	copper	7440-50-8	19.177	6.01	6.02	60141	60219
*deviation	< 10%					Sum in total:	100.00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com